

CBR08C389BCGAC

CBR-SMD RF COG, Ceramic, 3.8 pF, +/-0.1 pF, 500 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



Click here for the 3D model.

Dimensions		
Chip Size	0805	
L	2mm +/-0.2mm	
W	1.25mm +/-0.2mm	
Т	0.85mm +/-0.1mm	
В	0.5mm +/-0.2mm	

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Component Weight	10.7 mg
Notes	Solder Wave or Solder Reflow.
Shelf Life	78 Weeks
MSL	1

Specifications				
3.8 pF				
+/-0.1pF				
500 VDC				
750 VDC				
-55/+125°C				
COG				
0.21%				
0% Loss/Decade Hour				
10 GOhms				
476				

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